



Orderable: ChangeMe!	Designed for: Public Release	Mod. Date: 11/15/2016
TID #: PMP20440	Project Title: LM5140 Dual Phase Synchronous Buck	
Number: PMP20440	Rev: A	Sheet Title:
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 1 of 2
Drawn By:	File: PMP20440A_Sh1.SchDoc	Size: B
Engineer: R. Sheehan	Contact: http://www.ti.com/support	

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H1 NY PMS 440 0025 PH
 H2 NY PMS 440 0025 PH
 H3 NY PMS 440 0025 PH
 H4 NY PMS 440 0025 PH

H5 1902C
 H6 1902C
 H7 1902C
 H8 1902C

DNP FID1
 DNP FID2
 DNP FID3

PCB Number: PMP20440
 PCB Rev: A



PCB LOGO
 FCC disclaimer

Variant/Label Table	
Variant	Label Text
001	

LBL1
 PCB Label
 Size: 0.65" x 0.20"

ZZ1
 Label Assembly Note
 This Assembly Note is for PCB labels only

ZZ2
 Assembly Note
 These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3
 Assembly Note
 These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4
 Assembly Note
 These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

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